

TAZMO Apprecia Formosa Inc., subsidiary of TAZMO Co., Ltd. Is planning to exhibit at SEMICON TAIWAN 2022.

Date : Sep. 14th -16th

Location : Taipei Nangang Exhibition Center

Booth No. : L0930 (4F)

Panel exhibition :

- a) Temporary Bonding / Debonding **TWS series** for Power Devices.
- b) Temporary Bonding / Debonding **TWH series** for Advanced Package.
- c) Nanoimprint Lithography **Dyad™ series**.
- d) Panel Level Package Equipment **TZ series**.
- e) Clean Robot System **TT301A series** and **ET New series**.
- f) Pre-Aligner for Silicon Wafer(Backside VAC chucking) **MAF-R series**
- g) Phosphoric Acid Reclaim System **PSYRION®**
- h) Wet Single Cleaning & Etching System **CENOTE®**